

registration of the multi layers
PCBs

It has been designed to provide an easy preparation of multi-layer PCBs and offers an alternative to the mechanical system of joining the

layers with rivets and to the other systems. With this machine, the coupling of the inner-layers and pre-preg is obtained by carrying out multiple solder joints along the two edges of the pack by means of heated bits that operate at a variable pressure according to the number of internal layers, favouring the localized raction of the pre-preg.

